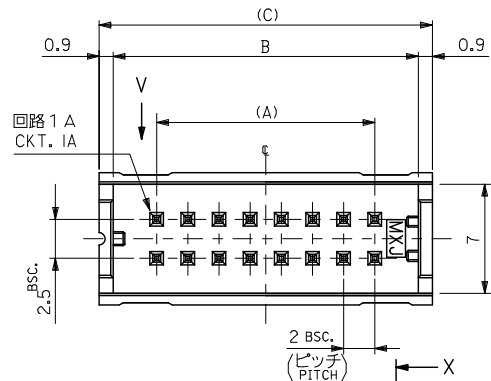
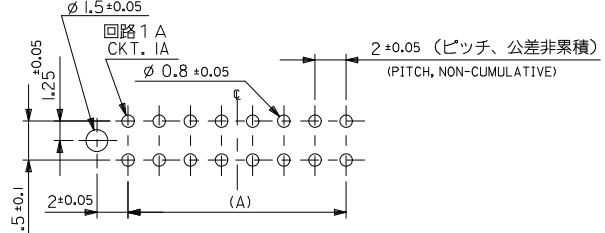
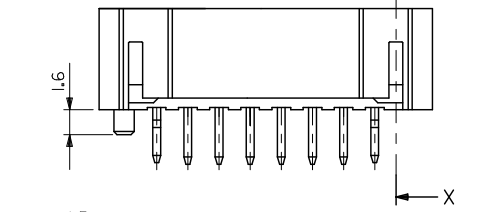
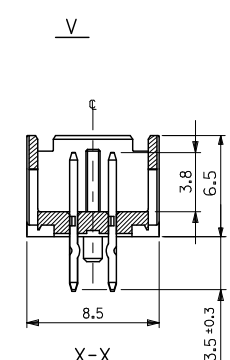
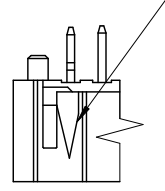


10 9 8 7 6 5 4 3 2 1



回路 1 A 表示  
CKT. 1A IDENTIFICATION



基板取付穴推奨寸法 (参考)  
RECOMMENDED PCB HOLE DIM.(REF.)

MATERIAL  
材料  
注記参照  
SEE NOTES

注記  
NOTES

1. 材料 :  
MATERIALS:  
ウエハー : ホリアミド、ガラス充填、UL94V-0、色 : グレー  
WAFER : PA, GLASS FILLED, UL94V-0, COLOR: GRAY  
ピン : 黄銅、スズメッキ  
PIN : BRASS, PRE-TINNED
2. 適合メスコネクター : 51089-\*\*\*5, 52478-\*\*\*15, 52484-\*\*\*15  
MATING CONNECTOR : 51089-\*\*\*5, 52478-\*\*\*15, 52484-\*\*\*15  
適合クリップ : 51094-\*\*\*00  
MATING CLIP : 51094-\*\*\*00
3. 推奨基板厚 :  
RECOMMENDED PCB THICKNESS : t
4. メッキ仕様  
TERMINAL PLATING  
表面メッキ : スズメッキ 1μm MIN.  
SURFACE PLATE : TIN 1μm MIN.  
下地メッキ : ニッケルメッキ 0.5μm MIN.  
UNDER PLATE : NICKEL 0.5μm MIN.
5. ELV AND RoHS COMPLIANT.

無鉛  
LEAD FREE

65.4	63.6	58	53313-6065	60
55.4	53.6	48	-5065	50
45.4	43.6	38	-4065	40
39.4	37.6	32	-3465	34
35.4	33.6	28	-3065	30
33.4	31.6	26	-2865	28
31.4	29.6	24	-2665	26
29.4	27.6	22	-2465	24
27.4	25.6	20	-2265	22
25.4	23.6	18	-2065	20
23.4	21.6	16	-1865	18
21.4	19.6	14	-1665	16
19.4	17.6	12	-1465	14
17.4	15.6	10	-1265	12
15.4	13.6	8	-1065	10
13.4	11.6	6	-0865	8
11.4	9.6	4	53313-0665	6
(C)	B	A	TRAY PACKAGE ORDER NO.	CKT.

REVISED IEC NO: J2010-0349 2009/08/31 DRWNTKON CHYOKASAKAWA 2009/08/31 APPR:NIKIITA 2009/08/31 (REV)	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	10 UNDER	±0.2	DRAWN BY A. IIDA	DATE 2003/05/07	TITLE 2.0 W/B DUAL ROW S/T HEADER ASSY		
	10 OVER 30 UNDER	±0.25	CHECKED BY J. MIYAZAWA	DATE 2003/05/07	MOLEX INCORPORATED		
	30 OVER	±0.3	APPROVED BY Y. ITO	DATE 2003/05/07	MATERIAL NO. SEE CHART	DOCUMENT NO. SD-53313-002	SHEET NO. 1 OF 1
ANGULAR ±3°		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			